

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: M. OGINO, et al.

Application No.: Rule 1.53(b) Continuation of U.S. Patent Application Serial
No. 10/134,364, filed April 30, 2002

Filed: On Even Date Herewith

For: WIRING TAPE FOR A SEMICONDUCTOR DEVICE
INCLUDING A BUFFER LAYER HAVING
INTERCONNECTED FOAMS

Art Unit in Parent: 2814

Examiner in Parent: H. Weiss

PRELIMINARY AMENDMENT

Commissioner for Patent
P.O. Box 1450
Alexandria, VA 22313-1450

April 23, 2004

Sir:

Prior to examination, please amend the above-identified application as listed
below and as set forth on the following pages:

Amendments to the Specification;

Amendments to the Claims; and

Remarks are following the amendments.